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### Understanding [Embedded - CPLDs \(Complex Programmable Logic Devices\)](#)

Embedded - CPLDs, or Complex Programmable Logic Devices, are highly versatile digital logic devices used in electronic systems. These programmable components are designed to perform complex logical operations and can be customized for specific applications. Unlike fixed-function ICs, CPLDs offer the flexibility to reprogram their configuration, making them an ideal choice for various embedded systems. They consist of a set of logic gates and programmable interconnects, allowing designers to implement complex logic circuits without needing custom hardware.

### Applications of Embedded - CPLDs

#### Details

Product Status	Obsolete
Programmable Type	In-System Reprogrammable™ (ISR™) CMOS
Delay Time tpd(1) Max	15 ns
Voltage Supply - Internal	3V ~ 3.6V
Number of Logic Elements/Blocks	-
Number of Macrocells	128
Number of Gates	-
Number of I/O	69
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	100-LQFP
Supplier Device Package	100-TQFP (14x14)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/infineon-technologies/cy37128vp100-83axc">https://www.e-xfl.com/product-detail/infineon-technologies/cy37128vp100-83axc</a>


**Selection Guide**
**5.0V Selection Guide**
*General Information*

Device	Macrocells	Dedicated Inputs	I/O Pins	Speed (t <sub>PD</sub> )	Speed (f <sub>MAX</sub> )
CY37032	32	5	32	6	200
CY37064	64	5	32/64	6	200
CY37128	128	5	64/128	6.5	167
CY37192	192	5	120	7.5	154
CY37256	256	5	128/160/192	7.5	154
CY37384	384	5	160/192	10	118
CY37512	512	5	160/192/264	10	118

*Speed Bins*

Device	200	167	154	143	125	100	83	66
CY37032	X		X		X			
CY37064	X		X		X			
CY37128		X			X	X		
CY37192			X		X		X	
CY37256			X		X		X	
CY37384					X		X	
CY37512					X	X	X	

*Device-Package Offering and I/O Count*

Device	44-Lead TQFP	44-Lead PLCC	44-Lead CLCC	84-Lead PLCC	84-Lead CLCC	100-Lead TQFP	160-Lead TQFP	160-Lead CQFP	208-Lead PQFP	208-Lead CQFP	292-Lead PBGA	388-Lead PBGA
CY37032	37	37										
CY37064	37	37	37	69		69						
CY37128				69	69	69	133					
CY37192							125					
CY37256							133	133	165		197	
CY37384									165		197	
CY37512									165	165	197	269

**3.3V Selection Guide**
*General Information*

Device	Macrocells	Dedicated Inputs	I/O Pins	Speed (t <sub>PD</sub> )	Speed (f <sub>MAX</sub> )
CY37032V	32	5	32	8.5	143
CY37064V	64	5	32/64	8.5	143
CY37128V	128	5	64/80/128	10	125
CY37192V	192	5	120	12	100
CY37256V	256	5	128/160/192	12	100
CY37384V	384	5	160/192	15	83
CY37512V	512	5	160/192/264	15	83

**Speed Bins**

Device	200	167	154	143	125	100	83	66
CY37032V				X		X		
CY37064V				X		X		
CY37128V					X		X	
CY37192V						X		X
CY37256V						X		X
CY37384V							X	X
CY37512V							X	X

**Device-Package Offering and I/O Count**

Device	44-Lead TQFP	44-Lead CLCC	48-Lead FBGA	84-Lead CLCC	100-Lead TQFP	100-Lead FBGA	160-Lead TQFP	160-Lead CQFP	208-Lead PQFP	208-Lead CQFP	292-Lead PBGA	256-Lead FBGA	388-Lead PBGA	400-Lead FBGA
CY37032V	37		37											
CY37064V	37	37	37		69	69								
CY37128V				69	69	85	133							
CY37192V							125							
CY37256V							133	133	165		197	197		
CY37384V									165		197			
CY37512V									165	165	197		269	269

**Architecture Overview of Ultra37000 Family**
**Programmable Interconnect Matrix**

The PIM consists of a completely global routing matrix for signals from I/O pins and feedbacks from the logic blocks. The PIM provides extremely robust interconnection to avoid fitting and density limitations.

The inputs to the PIM consist of all I/O and dedicated input pins and all macrocell feedbacks from within the logic blocks. The number of PIM inputs increases with pin count and the number of logic blocks. The outputs from the PIM are signals routed to the appropriate logic blocks. Each logic block receives 36 inputs from the PIM and their complements, allowing for 32-bit operations to be implemented in a single pass through the device. The wide number of inputs to the logic block also improves the routing capacity of the Ultra37000 family.

An important feature of the PIM is its simple timing. The propagation delay through the PIM is accounted for in the timing specifications for each device. There is no additional delay for traveling through the PIM. In fact, all inputs travel through the PIM. As a result, there are no route-dependent timing parameters on the Ultra37000 devices. The worst-case PIM delays are incorporated in all appropriate Ultra37000 specifications.

Routing signals through the PIM is completely invisible to the user. All routing is accomplished by software—no hand routing is necessary. *Warp*<sup>®</sup> and third-party development packages automatically route designs for the Ultra37000 family in a matter of minutes. Finally, the rich routing resources of the Ultra37000 family accommodate last minute logic changes while maintaining fixed pin assignments.

**Logic Block**

The logic block is the basic building block of the Ultra37000 architecture. It consists of a product term array, an intelligent product-term allocator, 16 macrocells, and a number of I/O cells. The number of I/O cells varies depending on the device used. Refer to *Figure 1* for the block diagram.

**Product Term Array**

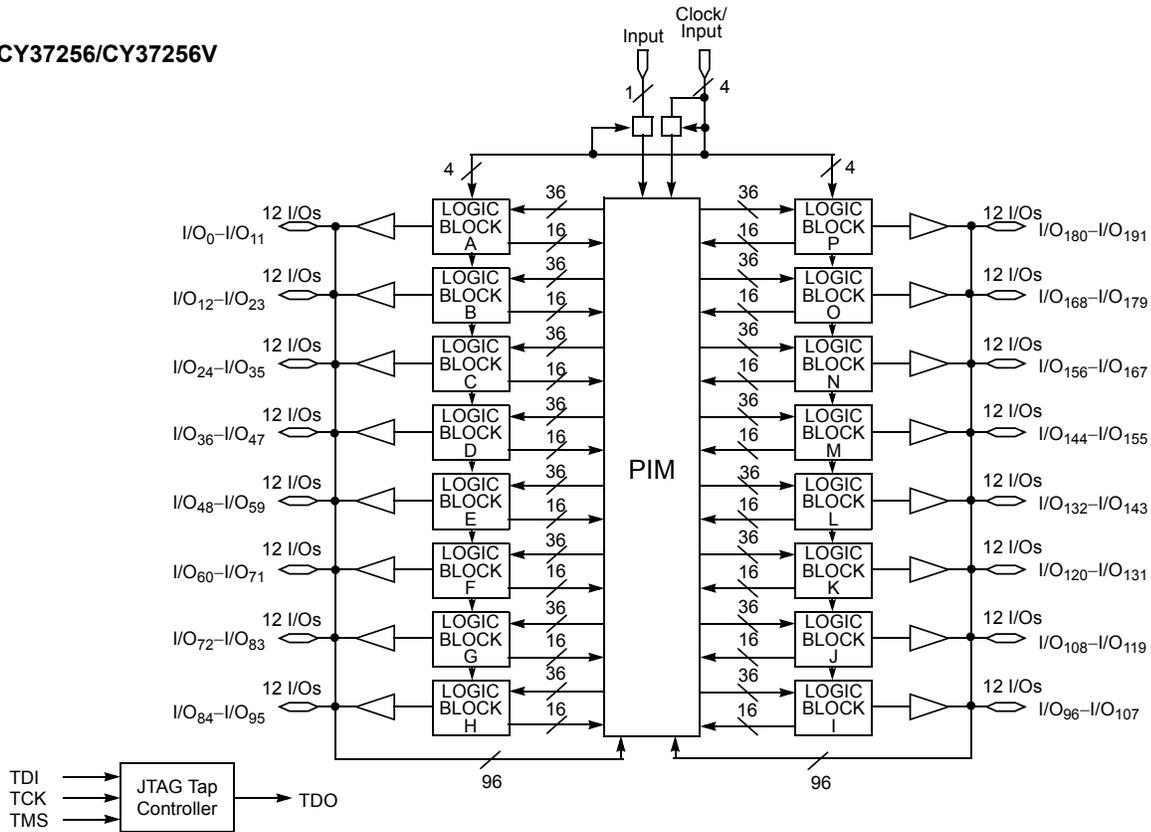
Each logic block features a 72 x 87 programmable product term array. This array accepts 36 inputs from the PIM, which originate from macrocell feedbacks and device pins. Active LOW and active HIGH versions of each of these inputs are generated to create the full 72-input field. The 87 product terms in the array can be created from any of the 72 inputs.

Of the 87 product terms, 80 are for general-purpose use for the 16 macrocells in the logic block. Four of the remaining seven product terms in the logic block are output enable (OE) product terms. Each of the OE product terms controls up to eight of the 16 macrocells and is selectable on an individual macrocell basis. In other words, each I/O cell can select between one of two OE product terms to control the output buffer. The first two of these four OE product terms are available to the upper half of the I/O macrocells in a logic block. The other two OE product terms are available to the lower half of the I/O macrocells in a logic block.

The next two product terms in each logic block are dedicated asynchronous set and asynchronous reset product terms. The final product term is the product term clock. The set, reset, OE and product term clock have polarity control to realize OR functions in a single pass through the array.

Logic Block Diagrams (continued)

CY37256/CY37256V



**Inductance<sup>[5]</sup>**

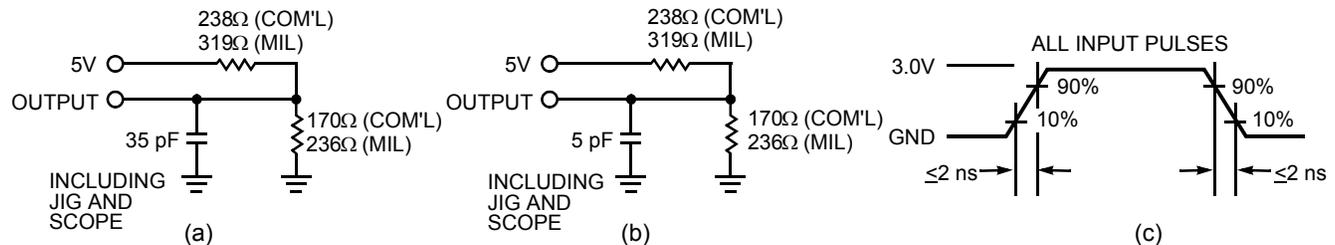
Parameter	Description	Test Conditions	44-Lead TQFP	44-Lead PLCC	44-Lead CLCC	84-Lead PLCC	84-Lead CLCC	100-Lead TQFP	160-Lead TQFP	208-Lead PQFP	Unit
L	Maximum Pin Inductance	$V_{IN} = 3.3V$ at $f = 1\text{ MHz}$	2	5	2	8	5	8	9	11	nH

**Capacitance<sup>[5]</sup>**

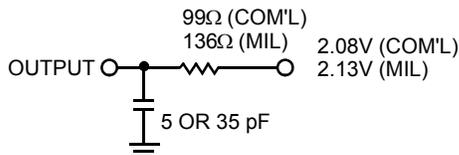
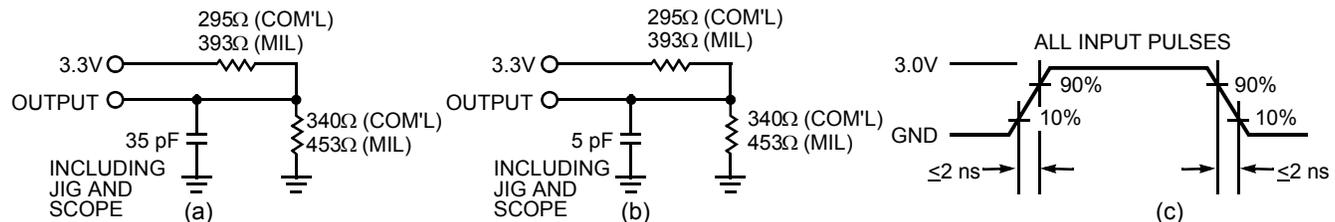
Parameter	Description	Test Conditions	Max.	Unit
$C_{I/O}$	Input/Output Capacitance	$V_{IN} = 3.3V$ at $f = 1\text{ MHz}$ at $T_A = 25^\circ C$	8	pF
$C_{CLK}$	Clock Signal Capacitance	$V_{IN} = 3.3V$ at $f = 1\text{ MHz}$ at $T_A = 25^\circ C$	12	pF
$C_{DP}$	Dual Functional Pins <sup>[9]</sup>	$V_{IN} = 3.3V$ at $f = 1\text{ MHz}$ at $T_A = 25^\circ C$	16	pF

**Endurance Characteristics<sup>[5]</sup>**

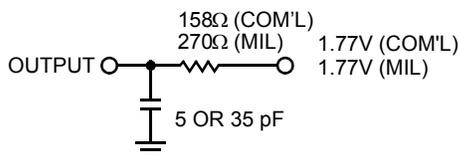
Parameter	Description	Test Conditions	Min.	Typ.	Unit
N	Minimum Reprogramming Cycles	Normal Programming Conditions <sup>[2]</sup>	1,000	10,000	Cycles

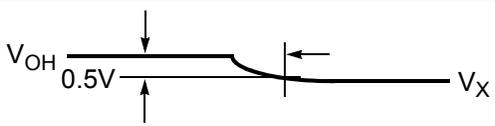
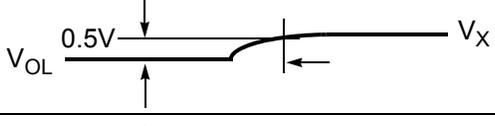
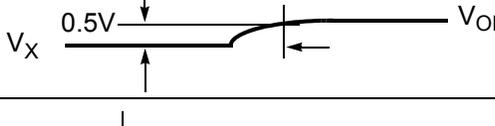
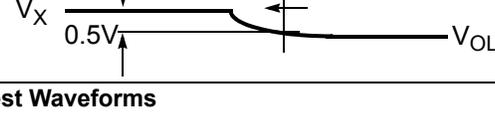
**AC Characteristics**
**5.0V AC Test Loads and Waveforms**


Equivalent to: THÉVENIN EQUIVALENT


**3.3V AC Test Loads and Waveforms**


Equivalent to: THÉVENIN EQUIVALENT



Parameter <sup>[11]</sup>	V <sub>X</sub>	Output Waveform—Measurement Level
t <sub>ER(-)</sub>	1.5V	
t <sub>ER(+)</sub>	2.6V	
t <sub>EA(+)</sub>	1.5V	
t <sub>EA(-)</sub>	V <sub>the</sub>	

**(d) Test Waveforms**
**Switching Characteristics** Over the Operating Range <sup>[12]</sup>

Parameter	Description	Unit
<b>Combinatorial Mode Parameters</b>		
t <sub>PD</sub> <sup>[13, 14, 15]</sup>	Input to Combinatorial Output	ns
t <sub>PDL</sub> <sup>[13, 14, 15]</sup>	Input to Output Through Transparent Input or Output Latch	ns
t <sub>PDLL</sub> <sup>[13, 14, 15]</sup>	Input to Output Through Transparent Input and Output Latches	ns
t <sub>EA</sub> <sup>[13, 14, 15]</sup>	Input to Output Enable	ns
t <sub>ER</sub> <sup>[11, 13]</sup>	Input to Output Disable	ns
<b>Input Register Parameters</b>		
t <sub>WL</sub>	Clock or Latch Enable Input LOW Time <sup>[8]</sup>	ns
t <sub>WH</sub>	Clock or Latch Enable Input HIGH Time <sup>[8]</sup>	ns
t <sub>IS</sub>	Input Register or Latch Set-up Time	ns
t <sub>IH</sub>	Input Register or Latch Hold Time	ns
t <sub>CO</sub> <sup>[13, 14, 15]</sup>	Input Register Clock or Latch Enable to Combinatorial Output	ns
t <sub>COL</sub> <sup>[13, 14, 15]</sup>	Input Register Clock or Latch Enable to Output Through Transparent Output Latch	ns
<b>Synchronous Clocking Parameters</b>		
t <sub>CO</sub> <sup>[14, 15]</sup>	Synchronous Clock (CLK <sub>0</sub> , CLK <sub>1</sub> , CLK <sub>2</sub> , or CLK <sub>3</sub> ) or Latch Enable to Output	ns
t <sub>S</sub> <sup>[13]</sup>	Set-Up Time from Input to Sync. Clk (CLK <sub>0</sub> , CLK <sub>1</sub> , CLK <sub>2</sub> , or CLK <sub>3</sub> ) or Latch Enable	ns
t <sub>H</sub>	Register or Latch Data Hold Time	ns
t <sub>CO2</sub> <sup>[13, 14, 15]</sup>	Output Synchronous Clock (CLK <sub>0</sub> , CLK <sub>1</sub> , CLK <sub>2</sub> , or CLK <sub>3</sub> ) or Latch Enable to Combinatorial Output Delay (Through Logic Array)	ns
t <sub>SCS</sub> <sup>[13]</sup>	Output Synchronous Clock (CLK <sub>0</sub> , CLK <sub>1</sub> , CLK <sub>2</sub> , or CLK <sub>3</sub> ) or Latch Enable to Output Synchronous Clock (CLK <sub>0</sub> , CLK <sub>1</sub> , CLK <sub>2</sub> , or CLK <sub>3</sub> ) or Latch Enable (Through Logic Array)	ns
t <sub>SL</sub> <sup>[13]</sup>	Set-Up Time from Input Through Transparent Latch to Output Register Synchronous Clock (CLK <sub>0</sub> , CLK <sub>1</sub> , CLK <sub>2</sub> , or CLK <sub>3</sub> ) or Latch Enable	ns
t <sub>HL</sub>	Hold Time for Input Through Transparent Latch from Output Register Synchronous Clock (CLK <sub>0</sub> , CLK <sub>1</sub> , CLK <sub>2</sub> , or CLK <sub>3</sub> ) or Latch Enable	ns

**Notes:**

11. t<sub>ER</sub> measured with 5-pF AC Test Load and t<sub>EA</sub> measured with 35-pF AC Test Load.
12. All AC parameters are measured with two outputs switching and 35-pF AC Test Load.
13. Logic Blocks operating in Low-Power Mode, add t<sub>LP</sub> to this spec.
14. Outputs using Slow Output Slew Rate, add t<sub>SLEW</sub> to this spec.
15. When V<sub>CC0</sub> = 3.3V, add t<sub>3,3IO</sub> to this spec.

**Switching Characteristics** Over the Operating Range <sup>[12]</sup>

Parameter	200 MHz		167 MHz		154 MHz		143 MHz		125 MHz		100 MHz		83 MHz		66 MHz		Unit
	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
<b>Combinatorial Mode Parameters</b>																	
$t_{PD}^{[13, 14, 15]}$		6		6.5		7.5		8.5		10		12		15		20	ns
$t_{PDL}^{[13, 14, 15]}$		11		12.5		14.5		16		16.5		17		19		22	ns
$t_{PDLL}^{[13, 14, 15]}$		12		13.5		15.5		17		17.5		18		20		24	ns
$t_{EA}^{[13, 14, 15]}$		8		8.5		11		13		14		16		19		24	ns
$t_{ER}^{[11, 13]}$		8		8.5		11		13		14		16		19		24	ns
<b>Input Register Parameters</b>																	
$t_{WL}$	2.5		2.5		2.5		2.5		3		3		4		5		ns
$t_{WH}$	2.5		2.5		2.5		2.5		3		3		4		5		ns
$t_{IS}$	2		2		2		2		2		2.5		3		4		ns
$t_{IH}$	2		2		2		2		2		2.5		3		4		ns
$t_{ICO}^{[13, 14, 15]}$		11		11		11		12.5		12.5		16		19		24	ns
$t_{ICOL}^{[13, 14, 15]}$		12		12		12		14		16		18		21		26	ns
<b>Synchronous Clocking Parameters</b>																	
$t_{CO}^{[14, 15]}$		4		4		4.5		6		6.5 <sup>[16]</sup>		6.5 <sup>[17]</sup>		8 <sup>[18]</sup>		10	ns
$t_S^{[13]}$	4		4		5		5		5.5 <sup>[16]</sup>		6 <sup>[17]</sup>		8 <sup>[18]</sup>		10		ns
$t_H$	0		0		0		0		0		0		0		0		ns
$t_{CO2}^{[13, 14, 15]}$		9.5		10		11		12		14		16		19		24	ns
$t_{SCS}^{[13]}$	5		6		6.5		7		8 <sup>[16]</sup>		10		12		15		ns
$t_{SL}^{[13]}$	7.5		7.5		8.5		9		10		12		15		15		ns
$t_{HL}$	0		0		0		0		0		0		0		0		ns
<b>Product Term Clocking Parameters</b>																	
$t_{COPT}^{[13, 14, 15]}$		7		10		10		13		13		13		15		20	ns
$t_{SPT}$	2.5		2.5		2.5		3		5		5.5		6		7		ns
$t_{HPT}$	2.5		2.5		2.5		3		5		5.5		6		7		ns
$t_{ISPT}^{[13]}$	0		0		0		0		0		0		0		0		ns
$t_{IHPT}$	6		6.5		6.5		7.5		9		11		14		19		ns
$t_{CO2PT}^{[13, 14, 15]}$		12		14		15		19		19		21		24		30	ns
<b>Pipelined Mode Parameters</b>																	
$t_{ICS}^{[13]}$	5		6		6		7		8 <sup>[16]</sup>		10		12		15		ns
<b>Operating Frequency Parameters</b>																	
$f_{MAX1}$	200		167		154		143		125 <sup>[16]</sup>		100		83		66		MHz
$f_{MAX2}$	200		200		200		167		154		153 <sup>[17]</sup>		125 <sup>[18]</sup>		100		MHz
$f_{MAX3}$	125		125		105		91		83		80 <sup>[17]</sup>		62.5		50		MHz
$f_{MAX4}$	167		167		154		125		118		100		83		66		MHz
<b>Reset/Preset Parameters</b>																	
$t_{RW}$	8		8		8		8		10		12		15		20		ns
$t_{RR}^{[13]}$	10		10		10		10		12		14		17		22		ns

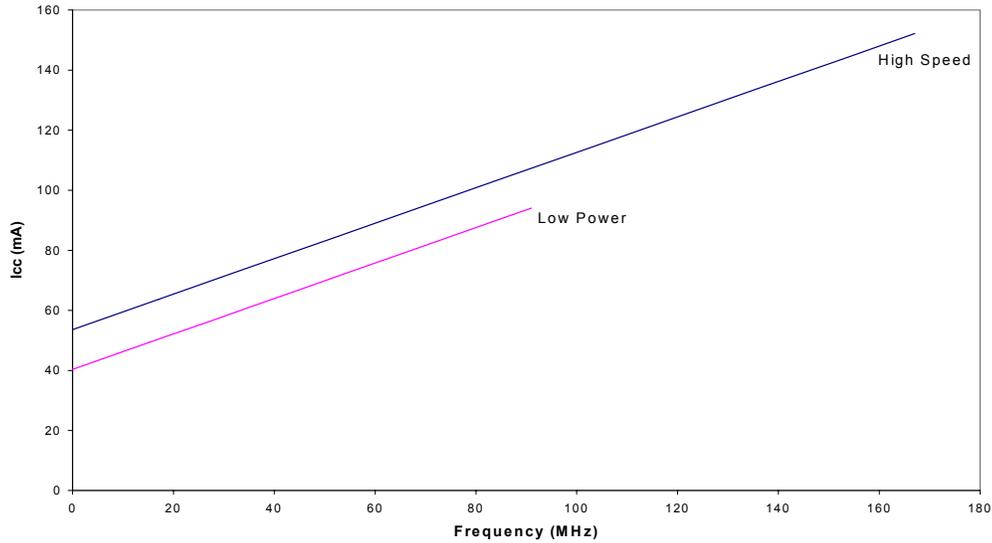
**Notes:**

16. The following values correspond to the CY37512 and CY37384 devices:  $t_{CO} = 5$  ns,  $t_S = 6.5$  ns,  $t_{SCS} = 8.5$  ns,  $t_{ICS} = 8.5$  ns,  $f_{MAX1} = 118$  MHz.

17. The following values correspond to the CY37192V and CY37256V devices:  $t_{CO} = 6$  ns,  $t_S = 7$  ns,  $f_{MAX2} = 143$  MHz,  $f_{MAX3} = 77$  MHz, and  $f_{MAX4} = 100$  MHz; and for the CY37512 devices:  $t_S = 7$  ns.

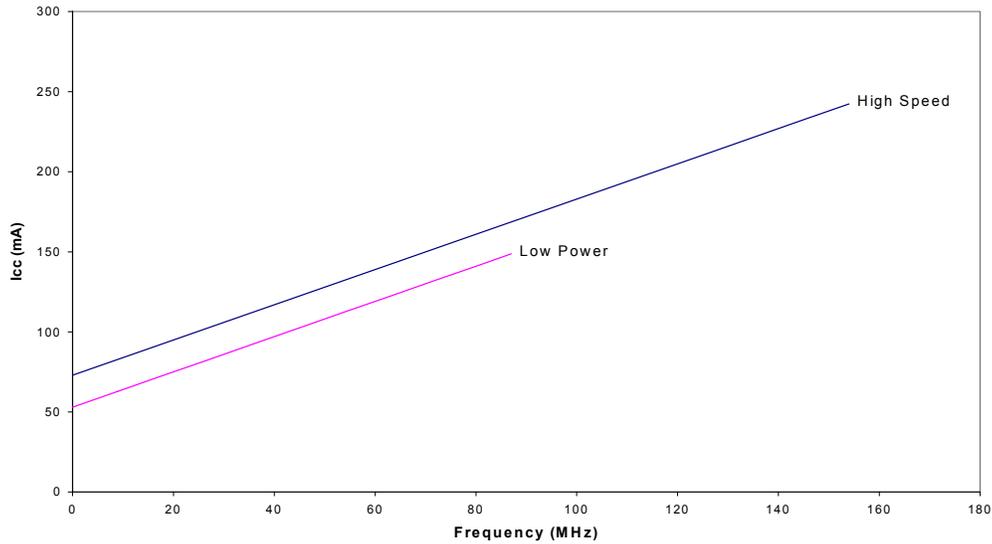
18. The following values correspond to the CY37512V and CY37384V devices:  $t_{CO} = 6.5$  ns,  $t_S = 9.5$  ns, and  $f_{MAX2} = 105$  MHz.

Typical 5.0V Power Consumption (continued)  
CY37128



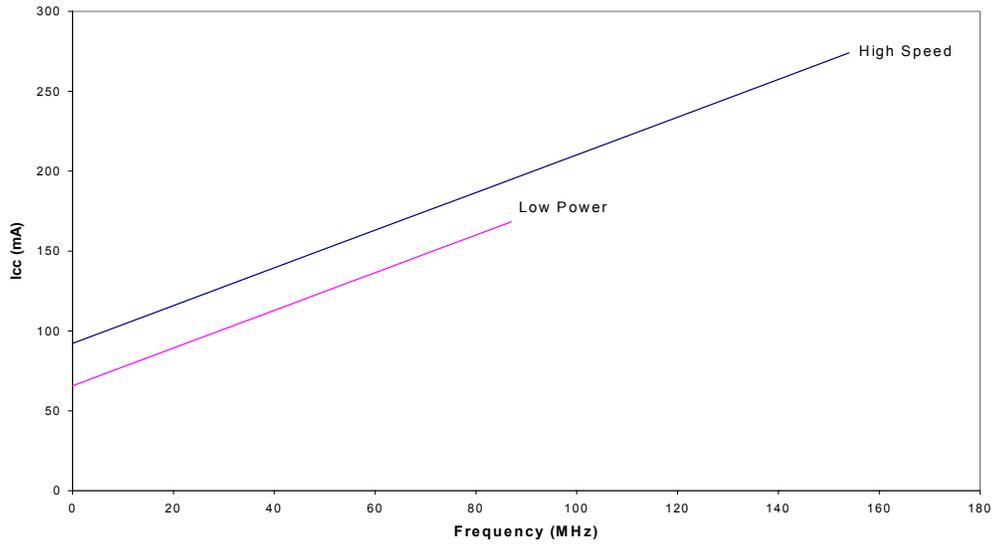
The typical pattern is a 16-bit up counter, per logic block, with outputs disabled.  
 $V_{CC} = 5.0V$ ,  $T_A = \text{Room Temperature}$

CY37192



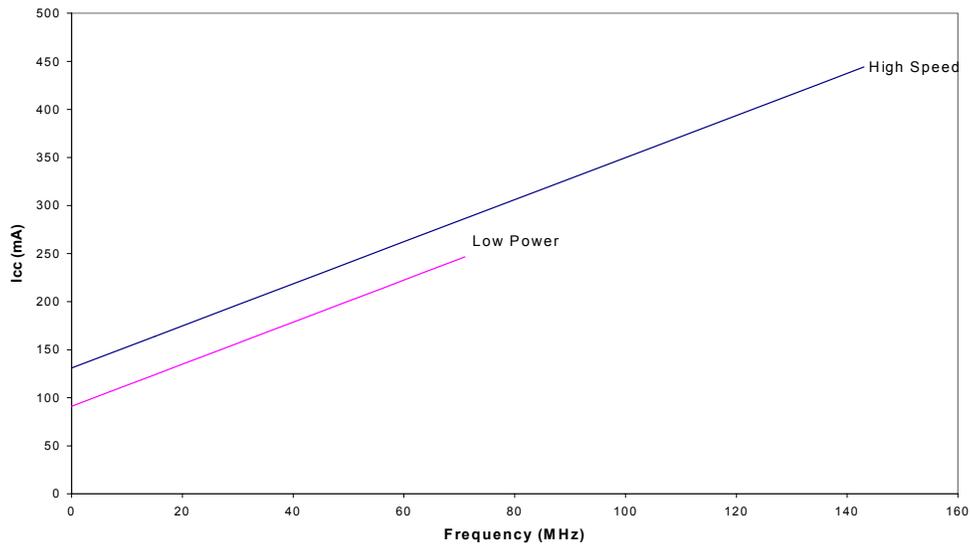
The typical pattern is a 16-bit up counter, per logic block, with outputs disabled.  
 $V_{CC} = 5.0V$ ,  $T_A = \text{Room Temperature}$

Typical 5.0V Power Consumption (continued)  
CY37256



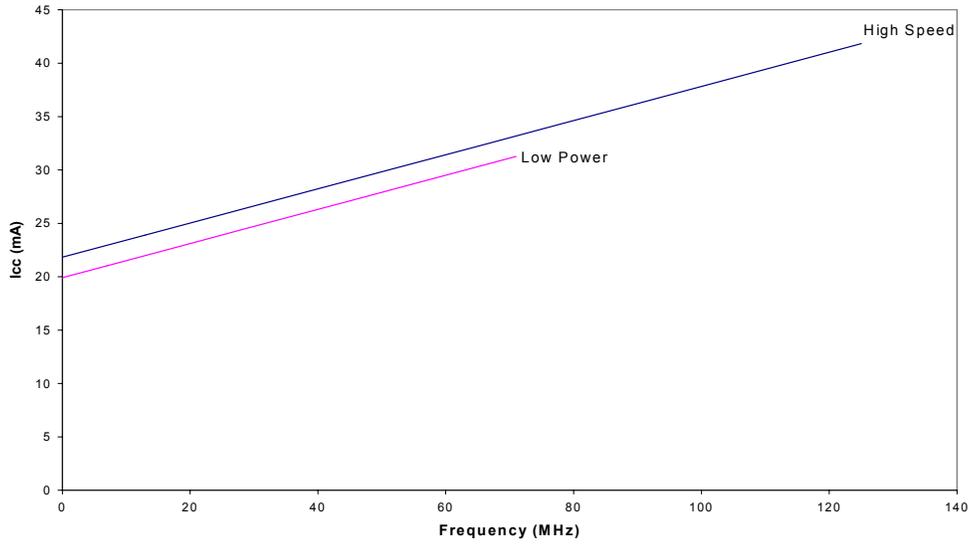
The typical pattern is a 16-bit up counter, per logic block, with outputs disabled.  
V<sub>CC</sub> = 5.0V, T<sub>A</sub> = Room Temperature

CY37384



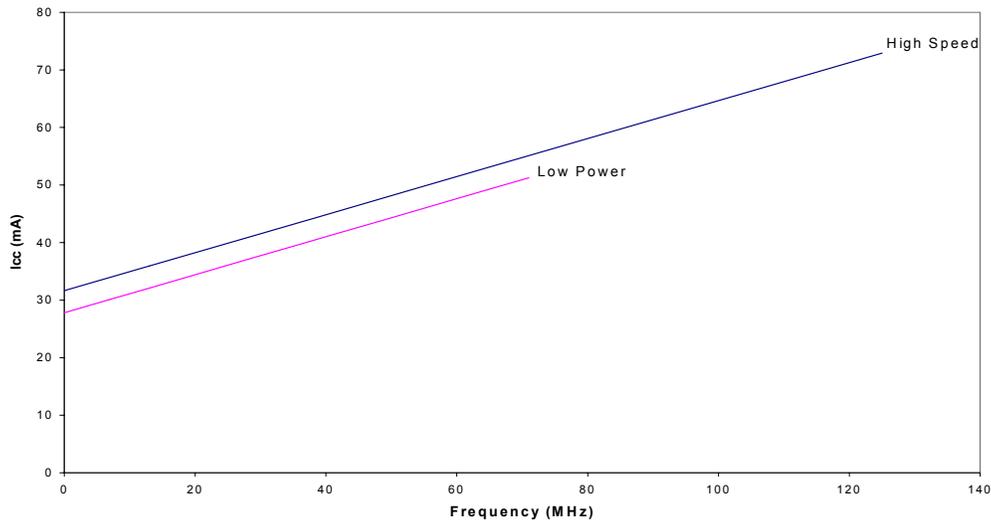
The typical pattern is a 16-bit up counter, per logic block, with outputs disabled.  
V<sub>CC</sub> = 5.0V, T<sub>A</sub> = Room Temperature

Typical 3.3V Power Consumption (continued)  
CY37064V



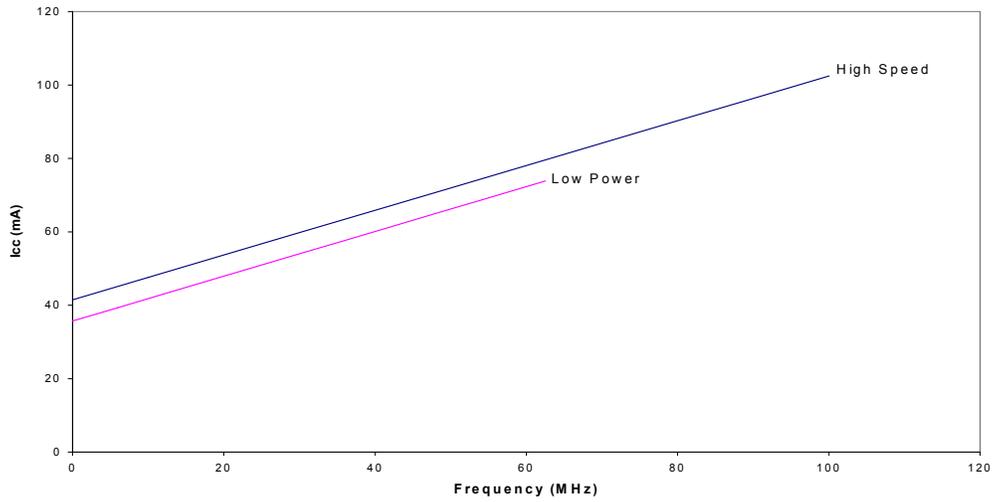
The typical pattern is a 16-bit up counter, per logic block, with outputs disabled.  
 $V_{CC} = 3.3V, T_A = \text{Room Temperature}$

CY37128V



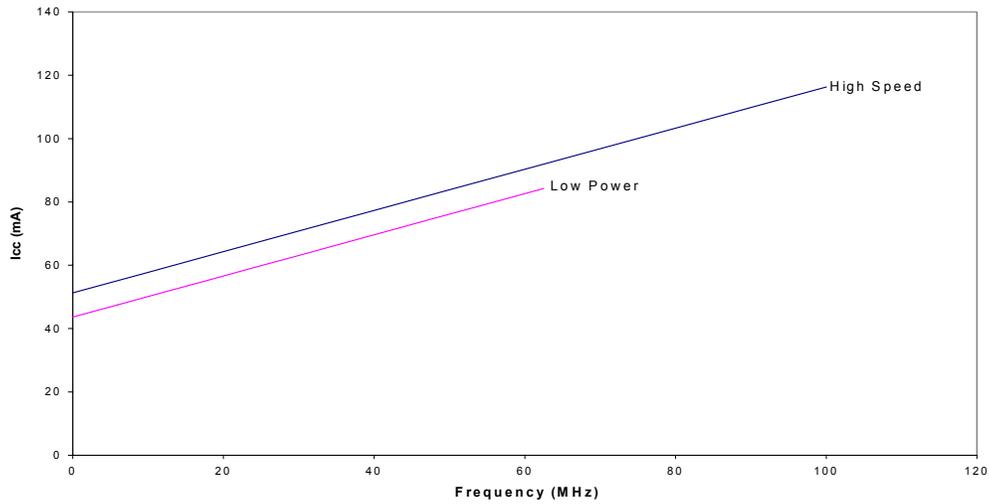
The typical pattern is a 16-bit up counter, per logic block, with outputs disabled.  
 $V_{CC} = 3.3V, T_A = \text{Room Temperature}$

Typical 3.3V Power Consumption (continued)  
CY37192V



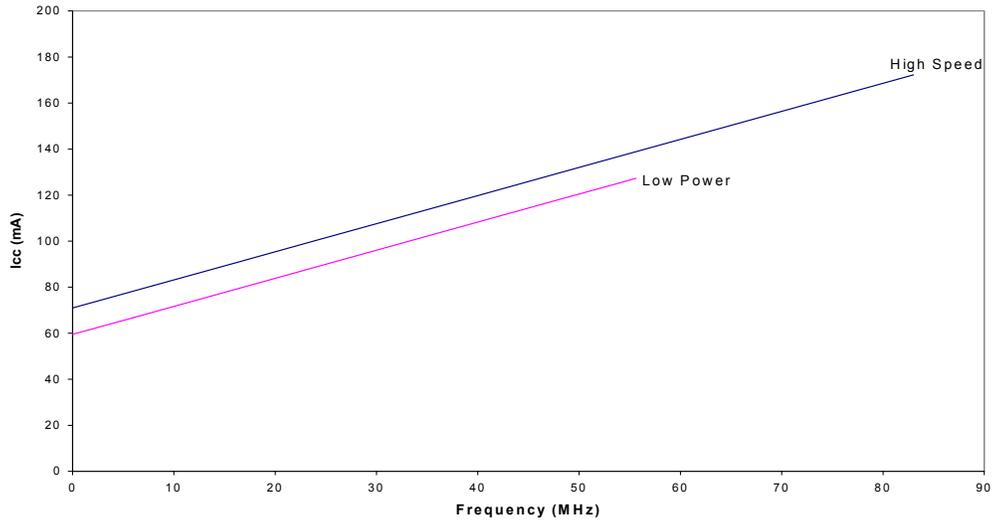
The typical pattern is a 16-bit up counter, per logic block, with outputs disabled.  
 $V_{CC} = 3.3V$ ,  $T_A = \text{Room Temperature}$

CY37256V



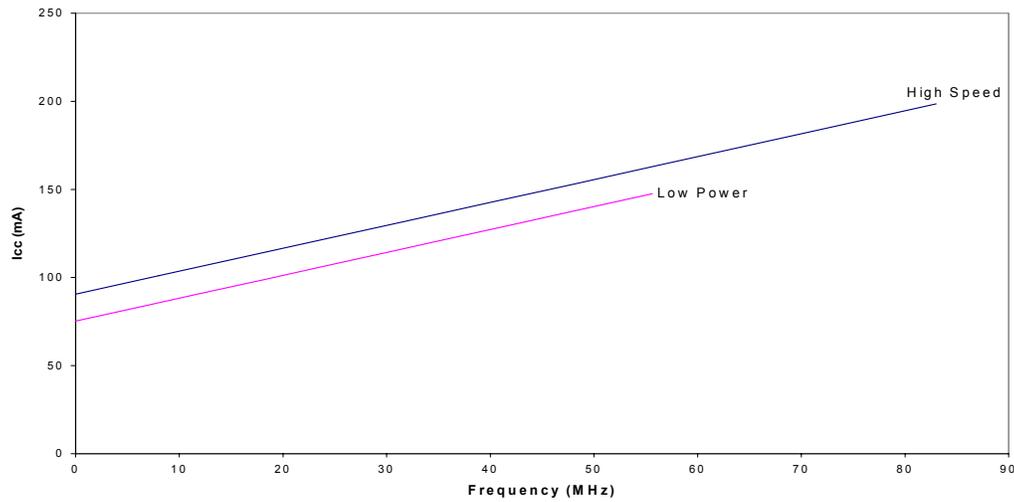
The typical pattern is a 16-bit up counter, per logic block, with outputs disabled.  
 $V_{CC} = 3.3V$ ,  $T_A = \text{Room Temperature}$

Typical 3.3V Power Consumption (continued)  
CY37384V



The typical pattern is a 16-bit up counter, per logic block, with outputs disabled.  
V<sub>CC</sub> = 3.3V, T<sub>A</sub> = Room Temperature

CY37512V



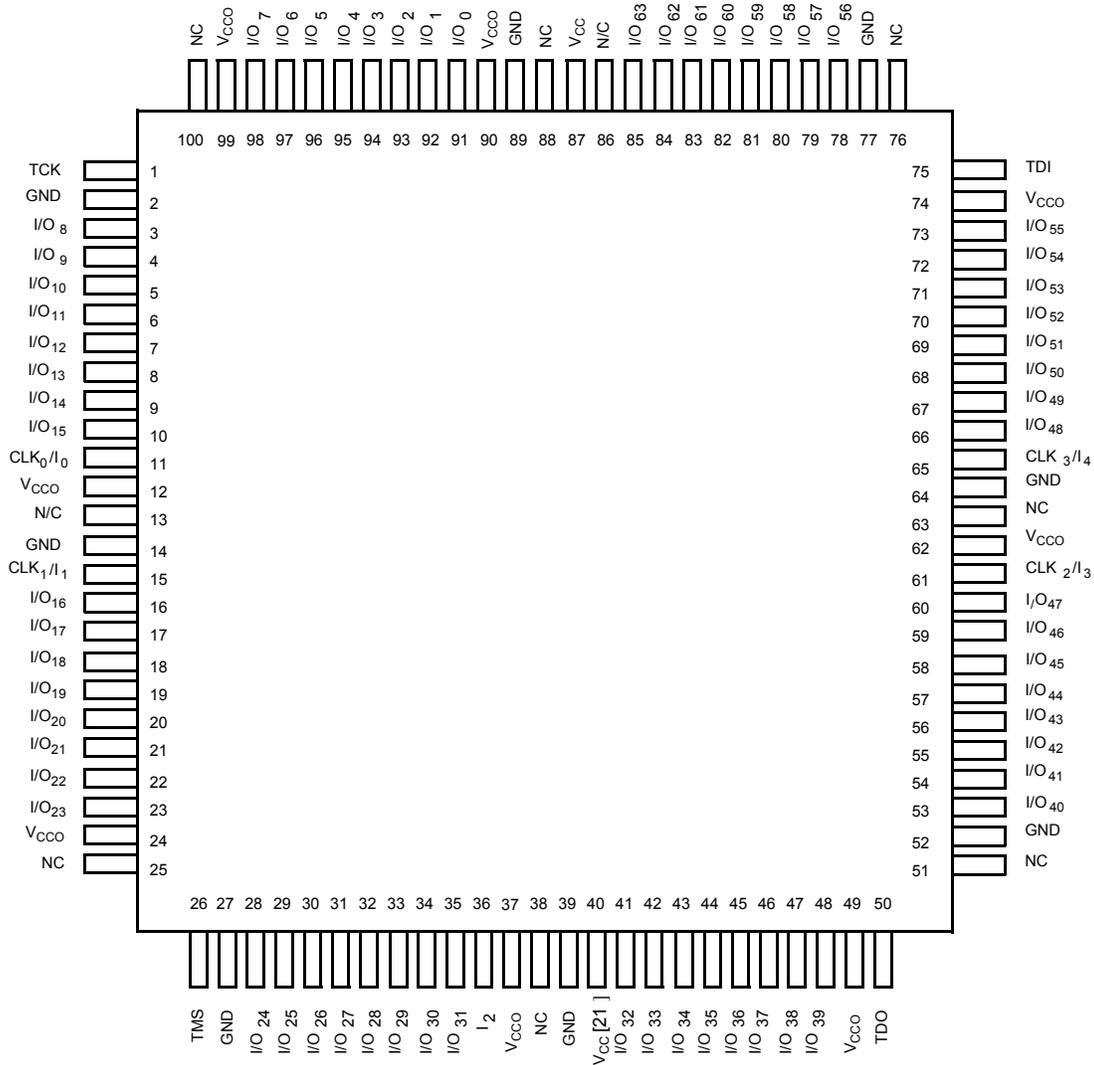
The typical pattern is a 16-bit up counter, per logic block, with outputs disabled.  
V<sub>CC</sub> = 3.3V, T<sub>A</sub> = Room Temperature



Pin Configurations<sup>[20]</sup> (continued)

100-lead TQFP (A100)

Top View




**Pin Configurations<sup>[20]</sup> (continued)**
**100-ball Fine-Pitch BGA (BB100) for CY37064V**
**Top View**

	1	2	3	4	5	6	7	8	9	10
A	NC	NC	I/O <sub>7</sub>	I/O <sub>5</sub>	I/O <sub>2</sub>	I/O <sub>62</sub>	I/O <sub>60</sub>	I/O <sub>58</sub>	I/O <sub>57</sub>	I/O <sub>56</sub>
B	I/O <sub>9</sub>	I/O <sub>8</sub>	I/O <sub>6</sub>	I/O <sub>4</sub>	I/O <sub>1</sub>	I/O <sub>63</sub>	V <sub>CC</sub>	I/O <sub>59</sub>	I/O <sub>55</sub>	NC
C	I/O <sub>10</sub>	TCK	V <sub>CC</sub>	I/O <sub>3</sub>	NC	NC	I/O <sub>61</sub>	V <sub>CC</sub>	TDI	I/O <sub>54</sub>
D	I/O <sub>11</sub>	NC	I/O <sub>12</sub>	I/O <sub>13</sub>	I/O <sub>0</sub>	NC	I/O <sub>51</sub>	I/O <sub>52</sub>	CLK <sub>3</sub> / I <sub>4</sub>	I/O <sub>53</sub>
E	I/O <sub>14</sub>	CLK <sub>0</sub> / I <sub>0</sub>	I/O <sub>15</sub>	NC	GND	GND	I/O <sub>48</sub>	I/O <sub>49</sub>	CLK <sub>2</sub> / I <sub>3</sub>	I/O <sub>50</sub>
F	I/O <sub>17</sub>	NC	NC	I/O <sub>16</sub>	GND	GND	NC	NC	I <sub>2</sub>	I/O <sub>47</sub>
G	I/O <sub>22</sub>	CLK <sub>1</sub> / I <sub>1</sub>	I/O <sub>21</sub>	I/O <sub>19</sub>	I/O <sub>18</sub>	I/O <sub>46</sub>	I/O <sub>45</sub>	I/O <sub>44</sub>	NC	I/O <sub>43</sub>
H	I/O <sub>23</sub>	TMS	V <sub>CC</sub>	I/O <sub>20</sub>	NC	I/O <sub>32</sub>	I/O <sub>42</sub>	V <sub>CC</sub>	TDO	I/O <sub>41</sub>
J	NC	I/O <sub>26</sub>	I/O <sub>28</sub>	NC	I/O <sub>31</sub>	I/O <sub>33</sub>	I/O <sub>35</sub>	I/O <sub>37</sub>	I/O <sub>39</sub>	I/O <sub>40</sub>
K	I/O <sub>24</sub>	I/O <sub>25</sub>	I/O <sub>27</sub>	I/O <sub>29</sub>	I/O <sub>30</sub>	I/O <sub>34</sub>	I/O <sub>36</sub>	I/O <sub>38</sub>	NC	NC

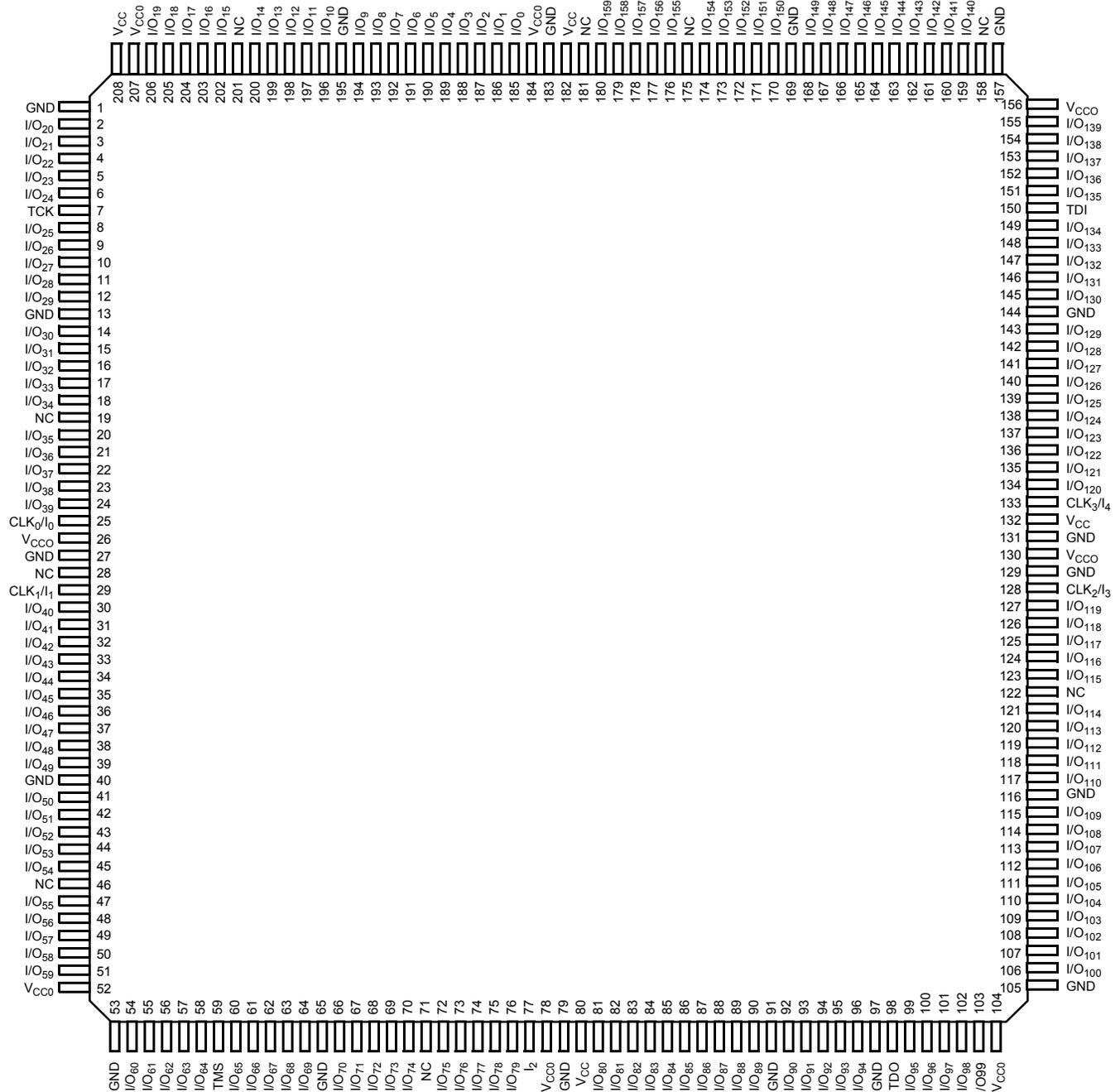
**100-ball Fine-Pitch BGA (BB100) for CY37128V**
**Top View**

	1	2	3	4	5	6	7	8	9	10
A	NC	I/O <sub>9</sub>	I/O <sub>8</sub>	I/O <sub>6</sub>	I/O <sub>3</sub>	I/O <sub>76</sub>	I/O <sub>74</sub>	I/O <sub>72</sub>	I/O <sub>71</sub>	I/O <sub>70</sub>
B	I/O <sub>11</sub>	I/O <sub>10</sub>	I/O <sub>7</sub>	I/O <sub>5</sub>	I/O <sub>2</sub>	I/O <sub>77</sub>	V <sub>CC</sub>	I/O <sub>73</sub>	I/O <sub>68</sub>	I/O <sub>69</sub>
C	I/O <sub>12</sub>	I/O <sub>13</sub> TCK	V <sub>CC</sub>	I/O <sub>4</sub>	I/O <sub>1</sub>	I/O <sub>78</sub>	I/O <sub>75</sub>	V <sub>CC</sub>	I/O <sub>67</sub> TDI	I/O <sub>66</sub>
D	I/O <sub>14</sub>	NC	I/O <sub>15</sub>	I/O <sub>16</sub>	I/O <sub>0</sub>	I/O <sub>79</sub>	I/O <sub>63</sub>	I/O <sub>64</sub>	CLK <sub>3</sub> / I <sub>4</sub>	I/O <sub>65</sub>
E	I/O <sub>17</sub>	CLK <sub>0</sub> / I <sub>0</sub>	I/O <sub>18</sub>	I/O <sub>19</sub>	GND	GND	I/O <sub>60</sub>	I/O <sub>61</sub>	CLK <sub>2</sub> / I <sub>3</sub>	I/O <sub>62</sub>
F	I/O <sub>22</sub>	JTAG EN	I/O <sub>21</sub>	I/O <sub>20</sub>	GND	GND	I/O <sub>59</sub>	I/O <sub>58</sub>	I <sub>2</sub>	I/O <sub>57</sub>
G	I/O <sub>27</sub>	CLK <sub>1</sub> / I <sub>1</sub>	I/O <sub>26</sub>	I/O <sub>24</sub>	I/O <sub>23</sub>	I/O <sub>56</sub>	I/O <sub>55</sub>	I/O <sub>54</sub>	NC	I/O <sub>53</sub>
H	I/O <sub>28</sub>	I/O <sub>33</sub> TMS	V <sub>CC</sub>	I/O <sub>25</sub>	I/O <sub>39</sub>	I/O <sub>40</sub>	I/O <sub>52</sub>	V <sub>CC</sub>	I/O <sub>47</sub> TDO	I/O <sub>51</sub>
J	I/O <sub>29</sub>	I/O <sub>32</sub>	I/O <sub>35</sub>	V <sub>CC</sub>	I/O <sub>38</sub>	I/O <sub>41</sub>	I/O <sub>43</sub>	I/O <sub>45</sub>	I/O <sub>48</sub>	I/O <sub>50</sub>
K	I/O <sub>30</sub>	I/O <sub>31</sub>	I/O <sub>34</sub>	I/O <sub>36</sub>	I/O <sub>37</sub>	I/O <sub>42</sub>	I/O <sub>44</sub>	I/O <sub>46</sub>	I/O <sub>49</sub>	NC



## Pin Configurations<sup>[20]</sup> (continued)

### 208-Lead PQFP (N208) / CQFP (U208) Top View





# Ultra37000 CPLD Family

## Pin Configurations<sup>[20]</sup> (continued)

### 388-Lead PBGA (BG388)

#### Top View

	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26
A	GND	GND	I/O <sub>19</sub>	I/O <sub>15</sub>	I/O <sub>13</sub>	I/O <sub>34</sub>	I/O <sub>31</sub>	I/O <sub>28</sub>	I/O <sub>25</sub>	I/O <sub>10</sub>	I/O <sub>7</sub>	I/O <sub>4</sub>	I/O <sub>1</sub>	I/O <sub>263</sub>	I/O <sub>260</sub>	I/O <sub>257</sub>	I/O <sub>254</sub>	I/O <sub>239</sub>	I/O <sub>237</sub>	I/O <sub>232</sub>	I/O <sub>229</sub>	I/O <sub>250</sub>	I/O <sub>248</sub>	I/O <sub>244</sub>	GND	GND
B	GND	NC	I/O <sub>18</sub>	I/O <sub>17</sub>	I/O <sub>14</sub>	I/O <sub>35</sub>	I/O <sub>32</sub>	I/O <sub>29</sub>	I/O <sub>26</sub>	I/O <sub>11</sub>	I/O <sub>8</sub>	I/O <sub>5</sub>	I/O <sub>2</sub>	V <sub>CC</sub>	I/O <sub>261</sub>	I/O <sub>258</sub>	I/O <sub>255</sub>	I/O <sub>252</sub>	I/O <sub>234</sub>	I/O <sub>231</sub>	I/O <sub>228</sub>	I/O <sub>249</sub>	I/O <sub>246</sub>	I/O <sub>245</sub>	I/O <sub>240</sub>	GND
C	I/O <sub>23</sub>	I/O <sub>38</sub>	I/O <sub>37</sub>	I/O <sub>16</sub>	I/O <sub>12</sub>	I/O <sub>33</sub>	I/O <sub>30</sub>	I/O <sub>27</sub>	I/O <sub>24</sub>	I/O <sub>9</sub>	I/O <sub>6</sub>	I/O <sub>3</sub>	I/O <sub>0</sub>	I/O <sub>262</sub>	I/O <sub>259</sub>	I/O <sub>256</sub>	I/O <sub>253</sub>	I/O <sub>238</sub>	I/O <sub>235</sub>	I/O <sub>233</sub>	I/O <sub>230</sub>	I/O <sub>251</sub>	I/O <sub>247</sub>	I/O <sub>225</sub>	I/O <sub>224</sub>	I/O <sub>227</sub>
D	I/O <sub>39</sub>	I/O <sub>40</sub>	I/O <sub>36</sub>	NC	NC	I/O <sub>21</sub>	I/O <sub>20</sub>	V <sub>CCO</sub>	V <sub>CCO</sub>	NC	GND	GND	V <sub>CCO</sub>	V <sub>CCO</sub>	GND	GND	NC	V <sub>CCO</sub>	V <sub>CCO</sub>	I/O <sub>236</sub>	I/O <sub>243</sub>	NC	NC	I/O <sub>226</sub>	I/O <sub>222</sub>	I/O <sub>223</sub>
E	I/O <sub>42</sub>	TCK	I/O <sub>41</sub>	NC																			NC	TDI	I/O <sub>221</sub>	I/O <sub>220</sub>
F	I/O <sub>45</sub>	I/O <sub>44</sub>	I/O <sub>43</sub>	I/O <sub>22</sub>																			I/O <sub>242</sub>	I/O <sub>219</sub>	I/O <sub>218</sub>	I/O <sub>217</sub>
G	I/O <sub>48</sub>	I/O <sub>47</sub>	I/O <sub>46</sub>	I/O <sub>63</sub>																			I/O <sub>241</sub>	I/O <sub>216</sub>	I/O <sub>215</sub>	I/O <sub>214</sub>
H	I/O <sub>49</sub>	I/O <sub>50</sub>	I/O <sub>51</sub>	V <sub>CCO</sub>																			V <sub>CCO</sub>	I/O <sub>211</sub>	I/O <sub>212</sub>	I/O <sub>213</sub>
J	I/O <sub>52</sub>	I/O <sub>53</sub>	I/O <sub>54</sub>	V <sub>CCO</sub>																			V <sub>CCO</sub>	I/O <sub>208</sub>	I/O <sub>209</sub>	I/O <sub>210</sub>
K	I/O <sub>55</sub>	I/O <sub>56</sub>	I/O <sub>57</sub>	NC																			NC	I/O <sub>205</sub>	I/O <sub>206</sub>	I/O <sub>207</sub>
L	I <sub>0</sub>	I/O <sub>59</sub>	I/O <sub>58</sub>	GND	GND						GND						GND						GND	I/O <sub>204</sub>	I <sub>4</sub>	I/O <sub>197</sub>
M	I/O <sub>61</sub>	I/O <sub>60</sub>	I <sub>1</sub>	GND	GND						GND						GND						GND	I <sub>3</sub>	I/O <sub>203</sub>	I/O <sub>202</sub>
N	I/O <sub>64</sub>	V <sub>CC</sub>	I/O <sub>62</sub>	V <sub>CCO</sub>	GND						GND						GND						V <sub>CCO</sub>	I/O <sub>201</sub>	I/O <sub>200</sub>	I/O <sub>199</sub>
P	I/O <sub>65</sub>	I/O <sub>66</sub>	I/O <sub>67</sub>	V <sub>CCO</sub>	GND						GND						GND						V <sub>CCO</sub>	I/O <sub>196</sub>	V <sub>CC</sub>	I/O <sub>198</sub>
R	I/O <sub>68</sub>	I/O <sub>69</sub>	I/O <sub>70</sub>	GND	GND						GND						GND						GND	I/O <sub>193</sub>	I/O <sub>194</sub>	I/O <sub>195</sub>
T	I/O <sub>71</sub>	I/O <sub>84</sub>	I/O <sub>85</sub>	GND	GND						GND						GND						GND	I/O <sub>178</sub>	I/O <sub>179</sub>	I/O <sub>192</sub>
U	I/O <sub>88</sub>	I/O <sub>87</sub>	I/O <sub>86</sub>	NC																			NC	I/O <sub>177</sub>	I/O <sub>176</sub>	I/O <sub>175</sub>
V	I/O <sub>91</sub>	I/O <sub>90</sub>	I/O <sub>89</sub>	V <sub>CCO</sub>																			V <sub>CCO</sub>	I/O <sub>174</sub>	I/O <sub>173</sub>	I/O <sub>172</sub>
W	I/O <sub>94</sub>	I/O <sub>93</sub>	I/O <sub>92</sub>	V <sub>CCO</sub>																			V <sub>CCO</sub>	I/O <sub>171</sub>	I/O <sub>170</sub>	I/O <sub>169</sub>
Y	I/O <sub>95</sub>	I/O <sub>72</sub>	I/O <sub>73</sub>	I/O <sub>110</sub>																			I/O <sub>153</sub>	I/O <sub>190</sub>	I/O <sub>191</sub>	I/O <sub>168</sub>
AA	I/O <sub>74</sub>	I/O <sub>75</sub>	I/O <sub>76</sub>	I/O <sub>111</sub>																			I/O <sub>152</sub>	I/O <sub>187</sub>	I/O <sub>188</sub>	I/O <sub>189</sub>
AB	I/O <sub>77</sub>	I/O <sub>78</sub>	I/O <sub>79</sub>	N/C																			NC	I/O <sub>184</sub>	I/O <sub>185</sub>	I/O <sub>186</sub>
AC	I/O <sub>81</sub>	I/O <sub>80</sub>	I/O <sub>108</sub>	N/C	NC	I/O <sub>112</sub>	I/O <sub>113</sub>	V <sub>CCO</sub>	V <sub>CCO</sub>	NC	GND	GND	V <sub>CCO</sub>	V <sub>CCO</sub>	GND	GND	NC	V <sub>CCO</sub>	V <sub>CCO</sub>	I/O <sub>150</sub>	I/O <sub>151</sub>	NC	NC	I/O <sub>155</sub>	I/O <sub>183</sub>	I/O <sub>182</sub>
AD	I/O <sub>109</sub>	I/O <sub>82</sub>	I/O <sub>83</sub>	I/O <sub>117</sub>	I/O <sub>97</sub>	I/O <sub>100</sub>	I/O <sub>102</sub>	I/O <sub>105</sub>	I/O <sub>120</sub>	I/O <sub>123</sub>	I/O <sub>126</sub>	I/O <sub>129</sub>	I <sub>2</sub>	I/O <sub>133</sub>	I/O <sub>136</sub>	I/O <sub>139</sub>	I/O <sub>142</sub>	I/O <sub>157</sub>	I/O <sub>159</sub>	I/O <sub>161</sub>	I/O <sub>163</sub>	I/O <sub>166</sub>	I/O <sub>146</sub>	I/O <sub>180</sub>	I/O <sub>181</sub>	I/O <sub>154</sub>
AE	GND	NC	I/O <sub>115</sub>	I/O <sub>116</sub>	I/O <sub>119</sub>	I/O <sub>98</sub>	I/O <sub>101</sub>	I/O <sub>103</sub>	I/O <sub>106</sub>	I/O <sub>121</sub>	I/O <sub>124</sub>	I/O <sub>127</sub>	V <sub>CC</sub>	I/O <sub>130</sub>	I/O <sub>134</sub>	I/O <sub>137</sub>	I/O <sub>140</sub>	I/O <sub>143</sub>	I/O <sub>160</sub>	I/O <sub>162</sub>	I/O <sub>165</sub>	I/O <sub>144</sub>	I/O <sub>147</sub>	I/O <sub>148</sub>	NC	GND
AF	GND	GND	I/O <sub>114</sub>	I/O <sub>118</sub>	I/O <sub>96</sub>	I/O <sub>99</sub>	TMS	I/O <sub>104</sub>	I/O <sub>107</sub>	I/O <sub>122</sub>	I/O <sub>125</sub>	I/O <sub>128</sub>	I/O <sub>131</sub>	I/O <sub>132</sub>	I/O <sub>135</sub>	I/O <sub>138</sub>	I/O <sub>141</sub>	I/O <sub>156</sub>	I/O <sub>158</sub>	TDO	I/O <sub>164</sub>	I/O <sub>167</sub>	I/O <sub>145</sub>	I/O <sub>149</sub>	GND	GND


**5.0V Ordering Information** (continued)

Macrocells	Speed (MHz)	Ordering Code	Package Name	Package Type	Operating Range	
64	154	CY37064P44-154AC	A44	44-Lead Thin Quad Flat Pack	Commercial	
		CY37064P44-154JC	J67	44-Lead Plastic Leaded Chip Carrier		
		CY37064P84-154JC	J83	84-Lead Plastic Leaded Chip Carrier		
		CY37064P100-154AC	A100	100-Lead Thin Quad Flat Pack		
		CY37064P44-154AI	A44	44-Lead Thin Quad Flat Pack	Industrial	
		CY37064P44-154AXI	A44	44-Lead Lead Free Thin Quad Flat Pack		
		CY37064P44-154JI	J67	44-Lead Plastic Leaded Chip Carrier		
		CY37064P44-154JXI	J67	44-Lead Lead Free Plastic Leaded Chip Carrier		
		CY37064P84-154JI	J83	84-Lead Plastic Leaded Chip Carrier		
		CY37064P100-154AI	A100	100-Lead Thin Quad Flat Pack		
	5962-9951902QYA	Y67	44-Lead Ceramic Leadless Chip Carrier	Military		
	125	125	CY37064P44-125AC	A44	44-Lead Thin Quad Flat Pack	Commercial
			CY37064P44-125AXC	A44	44-Lead Lead Free Thin Quad Flat Pack	
			CY37064P44-125JC	J67	44-Lead Plastic Leaded Chip Carrier	
			CY37064P44-125JXC	J67	44-Lead Lead Free Plastic Leaded Chip Carrier	
			CY37064P84-125JC	J83	84-Lead Plastic Leaded Chip Carrier	
			CY37064P100-125AC	A100	100-Lead Thin Quad Flat Pack	
			CY37064P100-125AXC	A100	100-Lead Lead Free Thin Quad Flat Pack	
			CY37064P44-125AI	A44	44-Lead Thin Quad Flat Pack	Industrial
			CY37064P44-125AXI	A44	44-Lead Lead Free Thin Quad Flat Pack	
			CY37064P44-125JI	J67	44-Lead Plastic Leaded Chip Carrier	
		CY37064P84-125JI	J83	84-Lead Plastic Leaded Chip Carrier		
		CY37064P100-125AI	A100	100-Lead Thin Quad Flat Pack		
CY37064P100-125AXI		A100	100-Lead Lead Free Thin Quad Flat Pack			
5962-9951901QYA	Y67	44-Lead Ceramic Leadless Chip Carrier	Military			

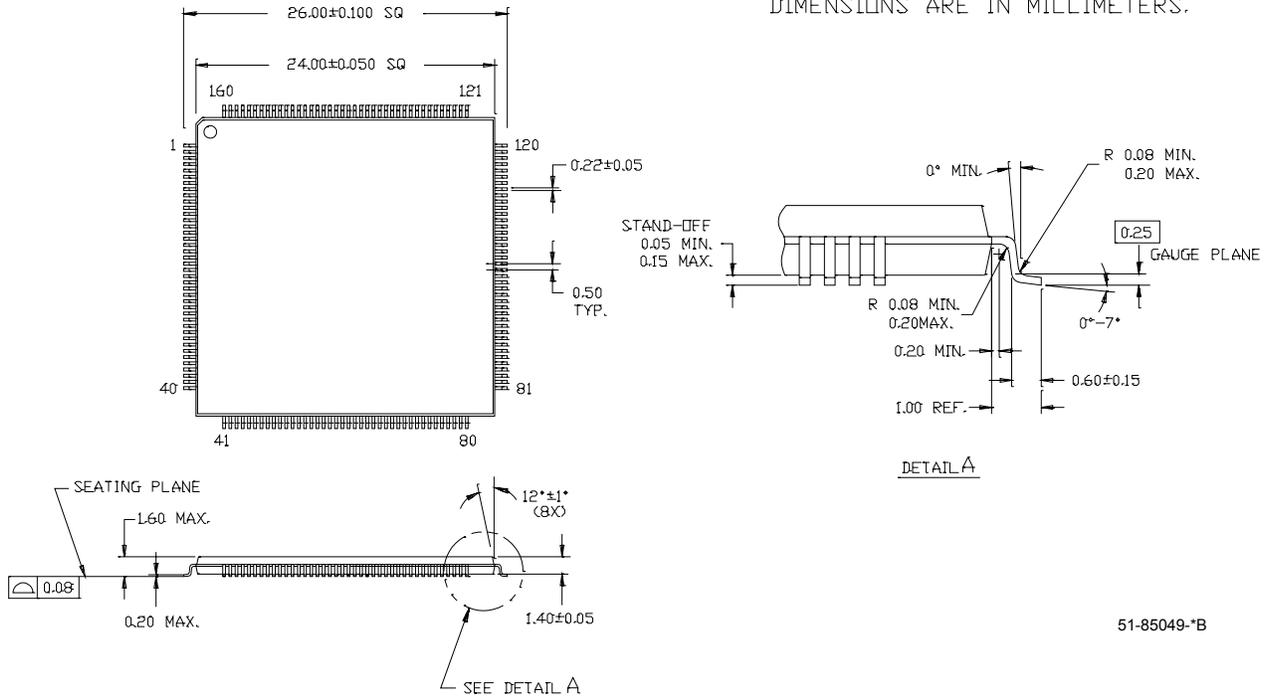

**3.3V Ordering Information** (continued)

Macrocells	Speed (MHz)	Ordering Code	Package Name	Package Type	Operating Range		
256	100	CY37256VP160-100AC	A160	160-Lead Thin Quad Flat Pack	Commercial		
		CY37256VP160-100AXC	A160	160-Lead Lead Free Thin Quad Flat Pack			
		CY37256VP208-100NC	N208	208-Lead Plastic Quad Flat Pack			
		CY37256VP256-100BGC	BG292	292-Ball Plastic Ball Grid Array			
		CY37256VP256-100BBC	BB256	256-Ball Fine-Pitch Ball Grid Array			
		CY37256VP160-100AI	A160	160-Lead Thin Quad Flat Pack		Industrial	
	CY37256VP160-100AXI	A160	160-Lead Lead Free Thin Quad Flat Pack				
	66	66	CY37256VP160-66AC	A160	160-Lead Thin Quad Flat Pack	Commercial	
			CY37256VP160-66AXC	A160	160-Lead Lead Free Thin Quad Flat Pack		
			CY37256VP208-66NC	N208	208-Lead Plastic Quad Flat Pack		
			CY37256VP256-66BGC	BG292	292-Ball Plastic Ball Grid Array		
		66	66	CY37256VP256-66BBC	BB256	256-Ball Fine-Pitch Ball Grid Array	Industrial
				CY37256VP160-66AI	A160	160-Lead Thin Quad Flat Pack	
				CY37256VP256-66BGI	BG292	292-Ball Plastic Ball Grid Array	
CY37256VP256-66BBI				BB256	256-Ball Fine-Pitch Ball Grid Array		
384	83	CY37384VP208-83NC	N208	208-Lead Plastic Quad Flat Pack	Commercial		
		CY37384VP256-83BGC	BG292	292-Ball Plastic Ball Grid Array			
	66	66	CY37384VP208-66NC	N208	208-Lead Plastic Quad Flat Pack	Commercial	
			CY37384VP256-66BGC	BG292	292-Ball Plastic Ball Grid Array		
		66	66	CY37384VP208-66NI	N208	208-Lead Plastic Quad Flat Pack	Industrial
				CY37384VP256-66BGI	BG292	292-Ball Plastic Ball Grid Array	
	512	83	CY37512VP208-83NC	N208	208-Lead Plastic Quad Flat Pack	Commercial	
			CY37512VP256-83BGC	BG292	292-Ball Plastic Ball Grid Array		
			CY37512VP352-83BGC	BG388	388-Ball Plastic Ball Grid Array		
			CY37512VP400-83BBC	BB400	400-Ball Fine-Pitch Ball Grid Array		
66		66	CY37512VP208-66NC	N208	208-Lead Plastic Quad Flat Pack	Commercial	
			CY37512VP256-66BGC	BG292	292-Ball Plastic Ball Grid Array		
			CY37512VP352-66BGC	BG388	388-Ball Plastic Ball Grid Array		
			CY37512VP400-66BBC	BB400	400-Ball Fine-Pitch Ball Grid Array		
			CY37512VP208-66NI	N208	208-Lead Plastic Quad Flat Pack		Industrial
			CY37512VP256-66BGI	BG292	292-Ball Plastic Ball Grid Array		
		CY37512VP352-66BGI	BG388	388-Ball Plastic Ball Grid Array			
		CY37512VP400-66BBI	BB400	400-Ball Fine-Pitch Ball Grid Array			
		66	66	CY37512VP400-66BBI	BB400	400-Ball Fine-Pitch Ball Grid Array	Industrial
				CY37512VP400-66BBI	BB400	400-Ball Fine-Pitch Ball Grid Array	
66	66	5962-9952601QZC	U208	208-Lead Ceramic Quad Flat Pack	Military		
		5962-9952601QZC	U208	208-Lead Ceramic Quad Flat Pack			

Package Diagrams (continued)

160-Lead Lead (Pb)-Free Thin Plastic Quad Flat Pack (24 x 24 x 1.4 mm) (TQFP) A160

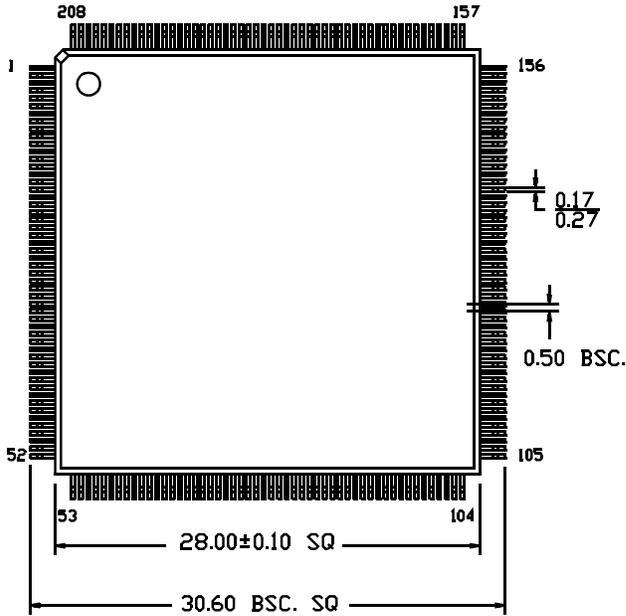
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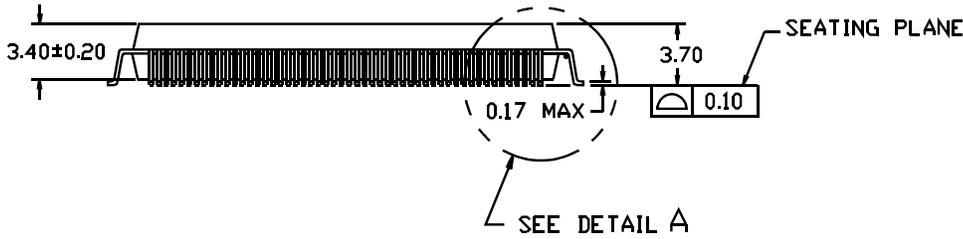
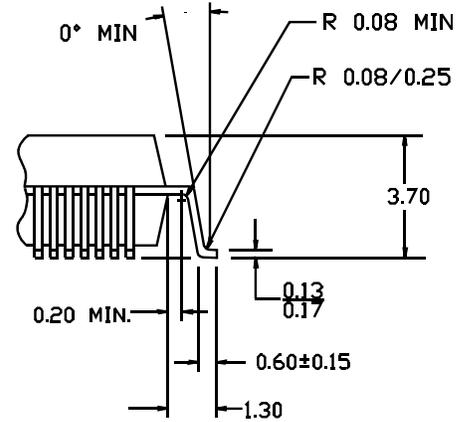
51-85049-B

Package Diagrams (continued)

208-Lead Plastic Quad Flatpack N208



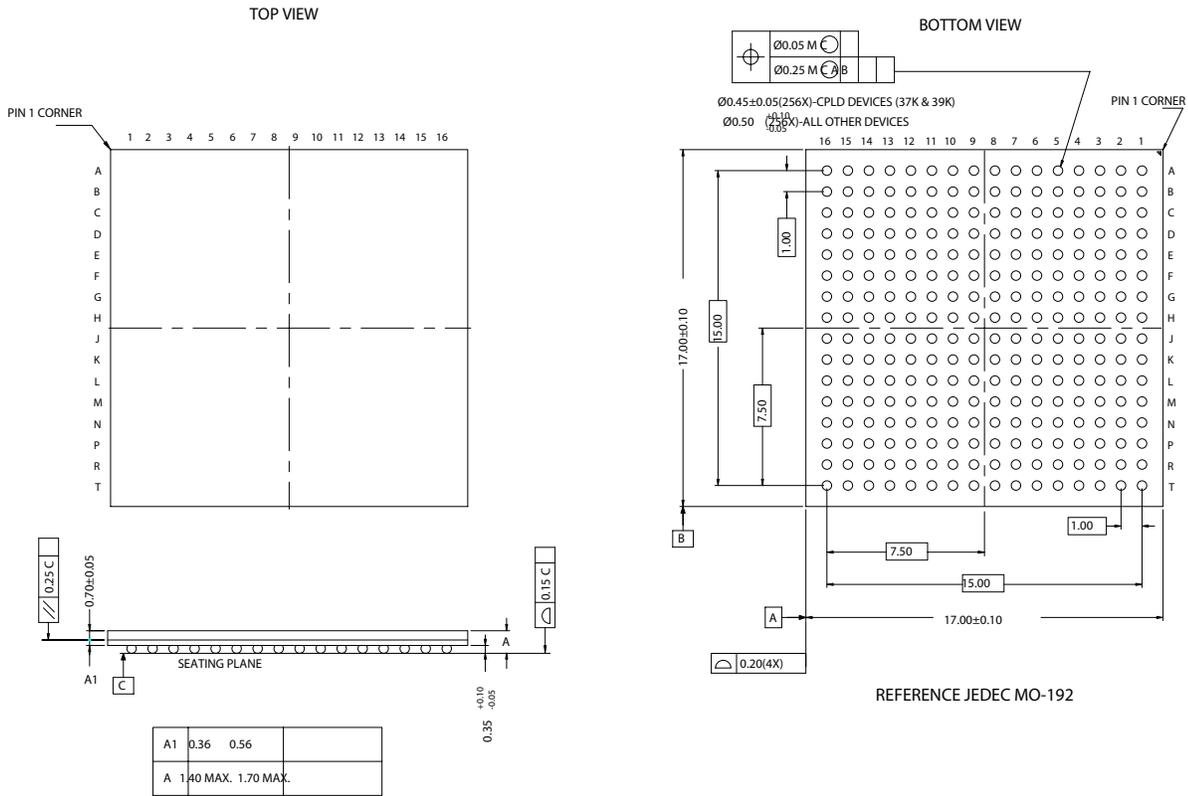
DIMENSIONS ARE IN MILLIMETERS



51-85069-\*B

Package Diagrams (continued)

256-Ball FBGA (17 x 17 mm) BB256



51-85108-\*F